

LASER INTERFEROMETER GRAVITATIONAL WAVE OBSERVATORY

-LIGO-

CALIFORNIA INSTITUTE OF TECHNOLOGY

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TCS HWS SLED Chassis, D1200614, Test Procedure		
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Performed by: _____

Date: _____

Board Serial Number: _____

1. Overview

The Thermal Compensation System (TCS) HWS superluminescent diode driver chassis provides current for the HWS SLEDs, reads out the photocurrent from a photodiode inside the SLED, and reads back and controls the temperature of the SLED using a thermistor and TEC, respectively (both also inside the SLED). This document will describe how to test each box, to ensure proper functionality.

2. Test Equipment

- 2.1 3x Power Supply capable of +/- 18V
- 2.2 Current source capable of 2mA.
- 2.3 Digital Multimeter (DMM)
- 2.4 Voltage Calibrator, or adjustable power supply
- 2.5 20 Ohm resistor rated for 2W.

3. Preliminaries

- 3.1 Perform visual inspection on board to check for missing components or solder deficiencies
- 3.2 Before connecting the power to the chassis, set power supply to +/- 18 Volts and then turn them off. Connect the power supply to the chassis under test at the back panel 3-pin power connector labeled "Power Input" paying attention to the values and polarities on the panel.

4. DC Tests

- 4.1 Turn on the +/- 18V power supplies to the system under test and then turn on the Chassis Power switch. Record the total current.

Measure	Expected Current	Observed Current	FP Leds On?
+18V Supply	270mA +/- 20mA		
-18V Supply	270mA +/- 20mA		

5. I/O Tests

Applies to SLED 1 and SLED 2 channels. All test procedures are the same for the two channels, except where called out.

- Power up the chassis by:
 - o Applying +/- 18V to the power connector on the rear of the chassis.
 - o Turn on switch
 - o Current draw expected = ??
 - o Check voltages on output test points:
 - TP1: $+5V \pm 0.05V$
 - TP3: $+15V \pm 0.15V$
 - TP6: $-15V \pm 0.15V$

To Be Tested:

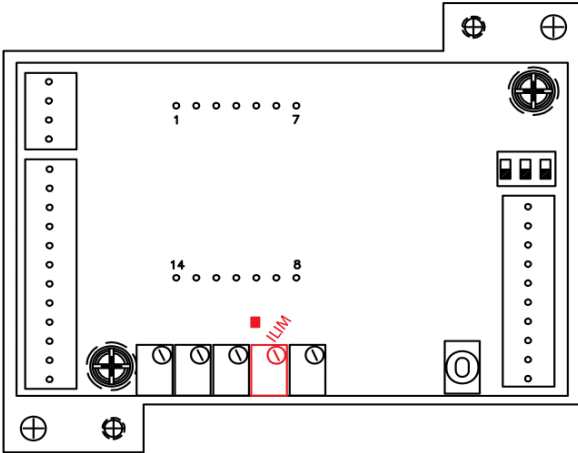
Beckhoff inputs/outputs (back panel)

- LD SHD 1
- Ext LD SET 1
- Ext T SET 1
- LD SHD 2
- Ext LD SET 2
- Ext T SET 2
- LD P MON 1
- LD I MON 1
- TEMP MON 1
- SET T MON 1
- LD P MON 2
- LD I MON 2
- TEMP MON 2
- SET T MON 2

SLED interface signals (front panel)

- PD Current 1
- LD Current 1
- TEC Cooler 1
- Thermistor 1
- PD Current 2
- LD Current 2
- TEC Cooler 2
- Thermistor 2

Limit Current Trimpot and Testpoint



1. Remove cover from LDTC driver module
2. Set dip switches modes to the following. The labels for the switches are only visible when the driver cover is in place.
 - a. LDREF: EXT (external laser diode reference)
 - b. CC|CP: INT (constant current setting)
 - c. TREF: EXT (external temperature reference)

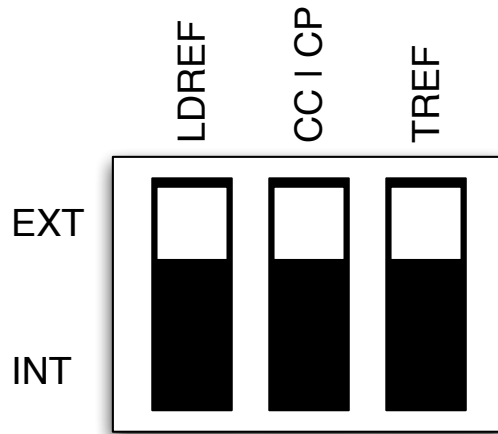


Figure 1: DIP switches on LDTC0520. Note: these labels are only visible when the driver cover is on.

3. Adjust ILIM (current limit) trimpot to set the maximum allowable current. Measure using the adjacent test point, shown in Figure 1, (transfer function = 250mA/V). Set ILIM according to the desired SLED indicated in the table below.

- a. Once the ILIM voltage has been set, attach a label to the front of the SLED driver chassis, next to the appropriate SLED 1 or SLED 2 channel, that indicates the Type and Part # that driver has been matched to.

Table 1: A list of the available super-luminescent diodes in aLIGO that the diode drivers must be matched to.

Location	Type	Part #	Op. current	Max current	ILIM voltage
HWS Y – SLED 2	QSDM-840-5	12.02.32	134 mA	147 mA	588 mV
HWS Y – SLED 2	QSDM-840-5	12.02.43	142 mA	156 mA	624 mV
HWS Y – SLED 2	QSDM-840-5	12.02.44	131 mA	144 mA	576 mV
HWS Y – SLED 2	QSDM-840-5	12.02.45	129 mA	142 mA	568 mV
HWS Y – SLED 2	QSDM-840-5	12.02.46	116 mA	128 mA	512 mV
HWS Y – SLED 2	QSDM-840-5	12.02.47	127 mA	140 mA	560 mV
HWS X – SLED 1	QSDM-790-5	12.05.21	165 mA	182 mA	728 mV
HWS X – SLED 1	QSDM-790-5	11.10.39	153 mA	168 mA	672 mV
HWS X – SLED 1	QSDM-790-5	11.10.40	145 mA	160 mA	640 mV
HWS X – SLED 1	QSDM-790-5	11.10.45	149 mA	164 mA	656 mV
HWS X – SLED 1	QSDM-790-5	11.10.51	160 mA	176 mA	704 mV
HWS X – SLED 1	QSDM-790-5	11.10.52	155 mA	170 mA	680 mV

4. Plug a 9-pin breakout board into the 9-pin output on the front panel
 - a. Connect one side of a 20 Ohm resistor, rated for 2W or less, to pins 4 and 5
 - b. Connect the other side of the resistor to pins 8 and 9
 - c. Connect a 1mA current source, to simulate the Photodiode (P), across pins 6 (PD Cathode) & 7 (PD Anode).
 - d. Short Laser Anode (Pin 8) to Photodiode cathode (PIN 6) on Breakout board
5. Connect a 15-pin breakout board to the 15-pin connector
 - a. Connect a 10kOhm RTD (or a 10kOhm trimpot) across pins 7 & 8
 - b. Connect one side of 10 Ohm resistor to pins 1 & 2
 - c. Connect the other side of the resistor to pins 3 & 4
6. Connect a 25-pin breakout board to the back of the chassis
 - a. *Check Temperature set and readback, T SET, TEMP MON, SET T MON*
 - i. SLED 1: Connect a voltage monitor across pins 7 (+) and 20 (-)
 - Confirm output voltage is $2V \pm 0.5V$ and varies as the “temperature RTD/trimpot” is varied.
 - ii. SLED 2: Connect a volt monitor across pins 11 (+) and 24 (-)
 - Confirm output voltage is $2V \pm 0.5V$ and varies as the “temperature RTD/trimpot” is varied.
 - iii. SLED1: Connect a voltage source, Vset, across pins 2 (+) & 4 (GND) – TEMPERATURE SET. This will attempt to drive temperature of the diode to one such that the resistance of the RTD, $R(\text{Temp}) = V_{\text{set}}/100\mu\text{A}$.
 - Set Vset to be 3.33V. Measure the SET TEMPERATURE VOLTAGE across pins 8 (+) and 21 (-). Confirm it is $2V \pm 0.05V$.
 - Set Vset to [2.5, 2.75, 3.0, 3.25, 3.5]V. Record the corresponding values of SET TEMPERATURE VOLTAGE
 - iv. SLED2: Connect a voltage source across pins 16 (+) & 4 (GND) – TEMPERATURE SET

- Set Vset to be 3.33V. Measure the SET TEMPERATURE VOLTAGE across pins 12 (+) and 25 (-). Confirm it is $2V \pm 0.05V$.
- Set Vset to [2.5, 2.75, 3.0, 3.25, 3.5]V. Record the corresponding values of SET TEMPERATURE VOLTAGE

b. Check photodiode readback, LD P MON

- i.* SLED1: Connect a voltage sensor to the 25-pin connector pins 5 (+) and 18(-) to sense LD P MON 1.
- ii.* Apply a current of 1mA to the 9-pin connector pins in Step 4c.
 - Confirm output voltage, LD P MON 1, is $2V \pm 0.05V$
- iii.* SLED2: Connect a voltage sensor to the 25-pin connector pins 9 (+) and 2(-) to sense LD P MON 2
- iv.* Apply a current of 1mA to the 9-pin connector pins in Step 4c.
 - Confirm output voltage, LD P MON 2, is $2V \pm 0.05V$

c. Check the laser shutdown and setpoint, LD SHD, LD SET, LD I MON.

- i.* Turn on the LDCT0520 laser diode module by moving the ON/OFF switch to the ON position.
- ii.* SLED 1: Connect a 0-5V signal (LD SHD) across pins 1 (+) & 4 (GND). Set it to 0V.
 - Measure the voltage across the 20 Ohm resistor attached in Step 4a. Confirm there is a voltage of $3V \pm 1.5V$ across this resistor.
 - Increase LD SHD from 0V to 5V. Confirm that $> 3V$ on LD SHD shuts down the current to the 20 Ohm resistor by observing the voltage across that resistor and confirming it drops to zero.
- iii.* SLED 1: Connect a voltage source, LD SET 1, across pins 14 (+) & 4 (GND)
- iv.* SLED 1: Connect a voltage sensor, LD I MON 1, across pins 6 (+) and 19 (-)
 - Set voltage LD SET 1 to 5V. Set LD SHD to 0V. Confirm that LD I MON 1 reads $1V \pm 0.05V$.
 - Turn LD SHD to 5V. Confirm that LD I MON 1 drops to $0V \pm 0.05V$.
 - Set LD SET 1 to [5, 8]V in 0.25V increments. Record that LD I MON 1 for these settings. Confirm that LD I MON 1 saturates at the predefined current limit, ILIM.
- v.* SLED 2: Connect a 5V signal (LD SHD 2) across pins 15 (+) & 4 (GND)
 - $> 3V$ shuts down the laser
- vi.* SLED 2: Connect a voltage source, LD SET 2, across pins 3 (+) & 4 (GND)
- vii.* SLED 2: Connect a voltage sensor, LD I MON 2, across pins 10 (+) and 23 (-)
 - Set voltage LD SET 2 to 5V. Set LD SHD to 0V. Confirm that LD I MON 2 reads approximately $1V \pm 0.05V$.
 - Turn LD SHD to 5V. Confirm that LD I MON 2 drops to $0V \pm 0.05V$.
 - Set LD SET 2 to [5, 8]V in 0.25V increments. Record that LD I MON 2 for these settings. Confirm that LD I MON 2 saturates at the predefined current limit, ILIM.

7. Connect a Newport 740 module with a test SLED to D1200614. Leave the 25-pin connector connected to D1200614

- a.* SLED1: Measure the TEMP MON +1 temperature monitor voltage for SLED driver 1 across pins 7 (+) and 20(-) on the 25-pin connector

- b. SLED 1: Connect a voltage source, V_{set} , across pins 2 (+) & 4 (GND) – TEMPERATURE SET.
 - i. Set V_{set} to [2.5, 2.75, 3.0, 3.25, 3.5]V. Record the corresponding values of TEMP MON +1 (the actual temperature). Confirm it is within 10% of the values recorded in step 6.a.iii.
- c. SLED2: Measure the TEMP MON +2 temperature monitor voltage for SLED driver 1 across pins 11(+) and 24(-) on the 25-pin connector
- d. SLED 2: Connect a voltage source across pins 16 (+) & 4 (GND) – TEMPERATURE SET
 - i. Set V_{set} to [2.5, 2.75, 3.0, 3.25, 3.5]V. Record the corresponding values of TEMP MON +1 (the actual temperature). Confirm it is within 10% of the values recorded in step 6.a.iv
 - ii.